

FTDI Chip

VA800A-SPI

USB 2.0 Hi-Speed to MPSSE SPI Module



1. Introduction

The **USB2.0 Hi-Speed to MPSSE SPI Module, VA800A-SPI**, is a small electronic circuit board, utilising the FTDI FT232H.

The 10 pin connector on the module fits directly to the FTDI VM800B and VM800C graphic display modules. This allows direct control of the EVE FT800 devices with an SPI interface from a USB host.

All USB signalling and protocols are handled on the module.

For full details of the FT232H IC, consult the FT232H datasheet, [DS_FT232H](#).

1.1 Features

-
- USB 2.0 Hi-Speed (480Mbps/Second) and Full Speed (12Mbps/Second) compatible
- Entire USB protocol handled on the chip – No USB-specific firmware programming required
- USB Type B micro connector
- USB bus powered
- Synchronous Serial (MPSSE) data rates of up to 30Mbps on SPI
- 1kByte receive and transmit buffers for high data throughput
- 3.3V Level IO
- Power indicator LED
- SPI SS# active indicator LED
- Adjustable receive buffer timeout
- Support for USB suspend and resume
- Low operating and USB suspend current
- Low USB bandwidth consumption
- UHCI / OHCI / EHCI host controller compatible
- -40°C to +85°C operating temperature range
- FTDI's FTDI Chip's royalty-free D2XX drivers eliminate the requirement for USB driver development in most cases

2 Description

The **USB2.0 Hi-Speed to MPSSE SPI Module** is a small electronic circuit board, utilising the FT232H. This device handles all the USB signalling and protocols. The module provides a fast, simple way to connect devices with 3.3 Volt digital interface to USB. For full details of the IC, consult the FT232H datasheet, [DS_FT232H](#).

The integrated FT232H device incorporates a command processor called the Multi-Protocol Synchronous Serial Engine (MPSSE). The purpose of the MPSSE command processor is to communicate with devices which use synchronous protocols (such as JTAG, SPI or I²C) in an efficient manner. Full details are available in the [MPSSE application note - AN_108](#).

The module is terminated by ten female pin headers which can be interfaced to a male header. Pin signals are compliant with CMOS logic at 3.3 volts.

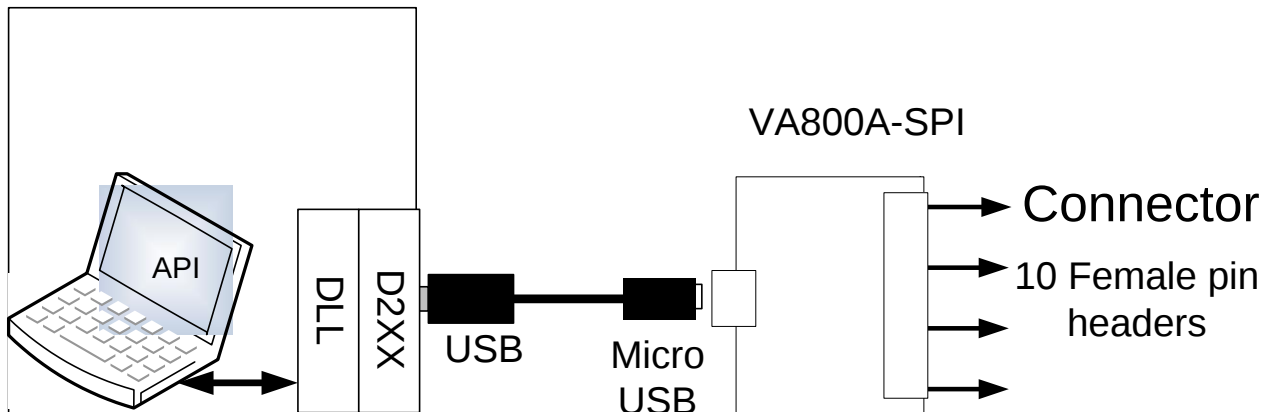
The FT232H is a single channel USB 2.0 Hi-Speed (480Mb/s) to UART/FIFO IC. It can be configured in a variety of industry standard serial or parallel interfaces at up to 30Mbps, such as MPSSE - JTAG, SPI, I²C.

The VA800A-SPI MPSSE module is configured for SPI only. The 10 pin connector fits to the VM800B and VM800C graphic display modules directly.

The module is powered from a USB host port and is USB2.0 Hi-Speed compatible.

The VA800A-SPI MPSSE module requires USB device drivers, available free from <http://www.ftdichip.com>. The D2XX driver is used with application software to directly access the FT232H in the module through a DLL. This is illustrated in the Figure 2-1

The VA800A-SPI MPSSE module uses the FTDI's FT232H USB to serial IC device.



Software application access to USB via D2XX

Figure 2-1 Using the VA800A-SPI MPSSE module

2.1 Ordering Information

The following Table 2-1 gives details of the available VA800A-SPI MPSSE modules.

Part Number	Description	End Connector	Cable details
VA800A-SPI	USB to SPI module	Single row, receptacle x 10	N.A.

Table 2-1 VA800A-SPI MPSSE module Descriptions and Part Numbers

Note 1: The VCC power output signal is 5.0V. The source of 5.0V is the USB VBUS input, which is switched onto the power output signal.

2.2 Certifications

The FTDI VA800A-SPI MPSSE modules are fully RoHS compliant. At the time of writing this datasheet the modules were being CE and FCC tested.

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3 Typical Applications

- Controlling the EVE series of graphics controllers
- USB to SPI interfaces
- Rapid USB integration into existing electronic systems
- Prototyping platform for USB interface on new systems

3.1 Driver Support

Royalty free D2XX *Direct* Drivers

(USB Drivers + DLL S/W Interface)

- Microsoft Windows 8 and 8 - 64-bit
- Microsoft Windows 7 and Windows 7 64-bit
- Microsoft Windows Vista and Vista 64-bit
- Microsoft Windows XP and XP 64-bit
- Microsoft Windows 2000, Server 2003, XP and Server 2008
- Microsoft Windows CE 4.2, 5.0 and 6.0
- Linux 2.6.32 or later

The drivers listed above are all available to download for free from
<http://www.ftdichip.com/Drivers/D2XX.htm>

4 VA800A-SPI MPSSE module connection and Mechanical Details

The following

Figure 4-1 VA800A-SPI MPSSE module layout shows the VA800A-SPI MPSSE module layout. The module is 29mm x 32mm in dimension.

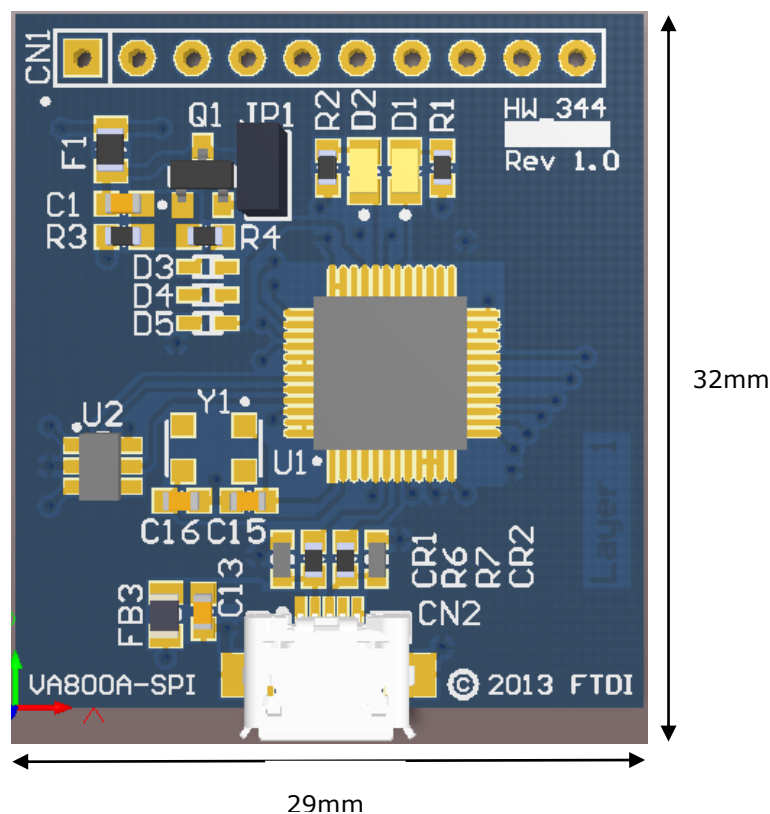


Figure 4-1 VA800A-SPI MPSSE module layout

The following Table 4-1 shows the module signals for these signals on the VA800A-SPI MPSSE module.

Pin No.	Name	Type	Description
CN1-1	SCLK	O	SPI Clock input
CN1-2	MOSI	O	Master Out Slave in
CN1-3	MISO	I	Master In Slave out
CN1-4	CS#	O	Chip select , active low
CN1-5	INT#	I	Interrupt
CN1-6	PD#	O	Active low, SPI device power down output.
CN1-7	5V	P	5V power supply
CN1-8	--	--	NC
CN1-9	GND	P	Ground
CN1-10	GND	P	Ground

Table 4-1 VA800A-SPI MPSSE module Connections (numbers refer to pad numbers on the PCB)

4.1 VA800A-SPI MPSSE module Electrical Parameters

Parameter	Description	Minimum	Typical	Maximum	Units	Conditions
VCC	Output Power Voltage	4.75	5	5.25	V	
I _o	Output Power Current	-	-	400	mA	
T	Operating Temperature Range	-40		+85	°C	

Table 4-2 VA800A-SPI MPSSE Operating Parameters

4.1.1 VA800A-SPI MPSSE module I/O Characteristics

Parameter	Description	Minimum	Typical	Maximum	Units	Conditions
V _{oh}	Output Voltage High	2.40	3.14		V	I _{oh} = +/-2mA I/O Drive strength* = 4mA
			3.20		V	I/O Drive strength* = 8mA
			3.22		V	I/O Drive strength* = 12mA
			3.22		V	I/O Drive strength* = 16mA
V _{ol}	Output Voltage Low		0.18	0.40	V	I _{ol} = +/-2mA I/O Drive strength* = 4mA
			0.12		V	I/O Drive strength* = 8mA
			0.08		V	I/O Drive strength* = 12mA
			0.07		V	I/O Drive strength* = 16mA
V _{il}	Input low Switching Threshold		-	0.80	V	LVTTL
V _{ih}	Input High Switching Threshold	2.00	-		V	LVTTL
V _t	Switching Threshold		1.50		V	LVTTL
V _{t-}	Schmitt trigger negative going threshold voltage	0.80	1.10	-	V	
V _{t+}	Schmitt trigger positive going threshold voltage		1.60	2.00	V	
R _{pu}	Input pull-up resistance	40	75	190	KΩ	V _{in} = 0
R _{pd}	Input pull-down resistance	40	75	190	KΩ	V _{in} = VCCIO

Parameter	Description	Minimum	Typical	Maximum	Units	Conditions
Iin	Input Leakage Current	15	45	85	μA	Vin = 0
Ioz	Tri-state output leakage current		±10		μA	Vin = 5.5V or 0

Table 4-3 VA800A-SPI MPSSE module I/O Pin Characteristics

* The I/O drive strength and slow slew-rate are configurable in the EEPROM.

The I/O pins are +3.3v cells, which are +5V tolerant

5 Module PCB Circuit Schematic

The circuit schematics for the small electronic board, utilising the FTDI FT232H, are shown in Figure 5-1 .

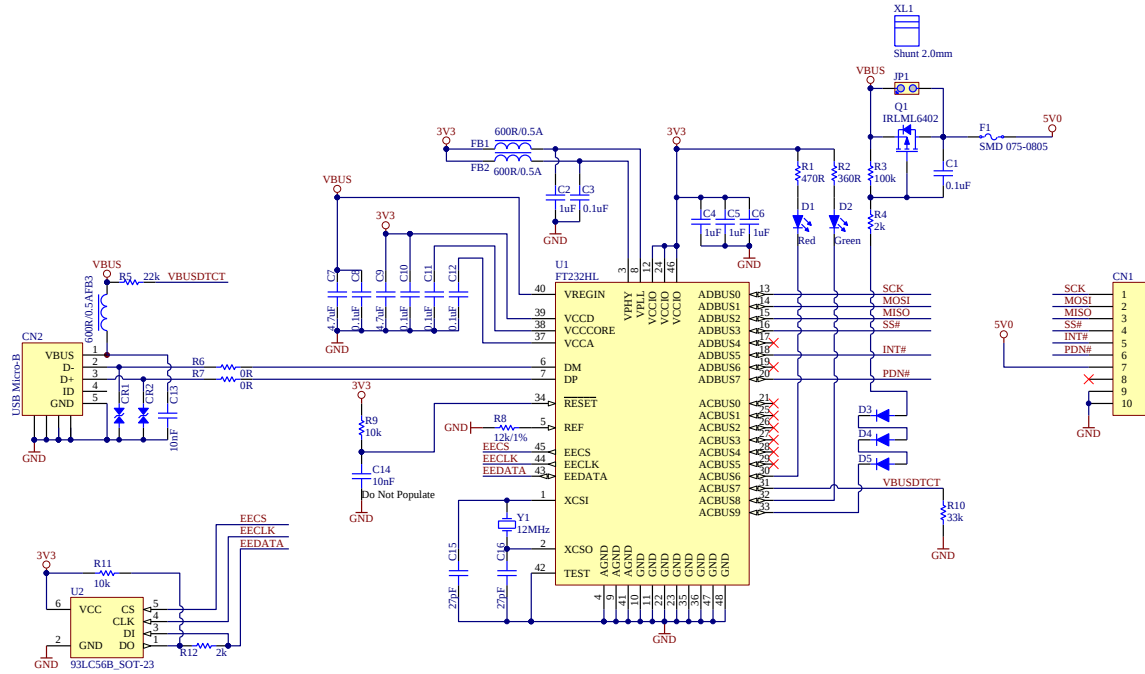


Figure 5-1 Circuit Schematic of VA800A-SPI

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Appendix A - Module EEPROM Configuration

Each VA800A-SPI MPSSE module is controlled by the FTDI FT232H IC. This FT232H device contains an EEPROM which contains the USB configuration descriptors for that device. When the module is plugged into a PC or a USB reset is performed, the PC will read these descriptors. The default values stored into the internal EEPROM are defined in the following table

Parameter	Value	Notes
USB Vendor ID (VID)	0403h	FTDI default VID (hex)
USB Product ID (PID)	6014h	FTDI default PID (hex)
Serial Number Enabled?	Yes	
Serial Number	See Note	A unique serial number is generated and programmed into the EEPROM during device final test.
Manufacturer Name	FTDI	
Product Description	See note	VA800A-SPI
Max Bus Power Current	500mA	Includes power available from the module plus power required for the FT232H
Power Source	Bus Powered	
Device Type	FT232H	
USB Version	0200	Returns USB 2.0 device description to the host. Note: The device is a USB 2.0 Hi-Speed device (480Mb/s).
Remote Wake Up	Disabled	500uA suspend limit when in this state
High Current I/Os	Enabled	Enables the high drive level on the CBUS I/O pins.
Invert TXD	Disabled	Signal on this pin becomes TXD# if enable.
Invert RXD	Disabled	Signal on this pin becomes RXD# if enable.
Invert RTS#	Disabled	Signal on this pin becomes RTS if enable.
Invert CTS#	Disabled	Signal on this pin becomes CTS if enable.

Default Internal EEPROM Configuration

Note:

The internal EEPROM in the module can be re-programmed over USB using the utility program FT_PROG. Both can be downloaded from www.ftdichip.com.

Appendix B - List of Figures and Tables

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Appendix C – Revision History

Version 1.0

First Release

24th October 2013